

**LOCTITE®**



# LOCTITE® 3D IND6845™

Tough  
Matte Black

**LOCTITE®**  
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**IND6845™**  
TOUGH



### LOCTITE 3D IND6845™

LOCTITE 3D IND6845 offers a solid balance of moderately high Heat Deflection Temperature (HDT) and toughness.

LOCTITE 3D IND6845 produces parts with smooth surfaces and fine details. In addition to its toughness, it has excellent impact resistance making it suitable for parts that are subject to wear and mechanical stress.

LOCTITE 3D IND6845 is TPO-free which contributes to better safety ratings in manufacturing environments.



#### Benefits:

- TPO-free and excellent H&S rating
- Unique balance of HDT and toughness
- Increased print speed



#### Ideal for:

- General industrial applications
- General end-use plastic parts
- Jigs, tooling, fixtures



#### Markets:



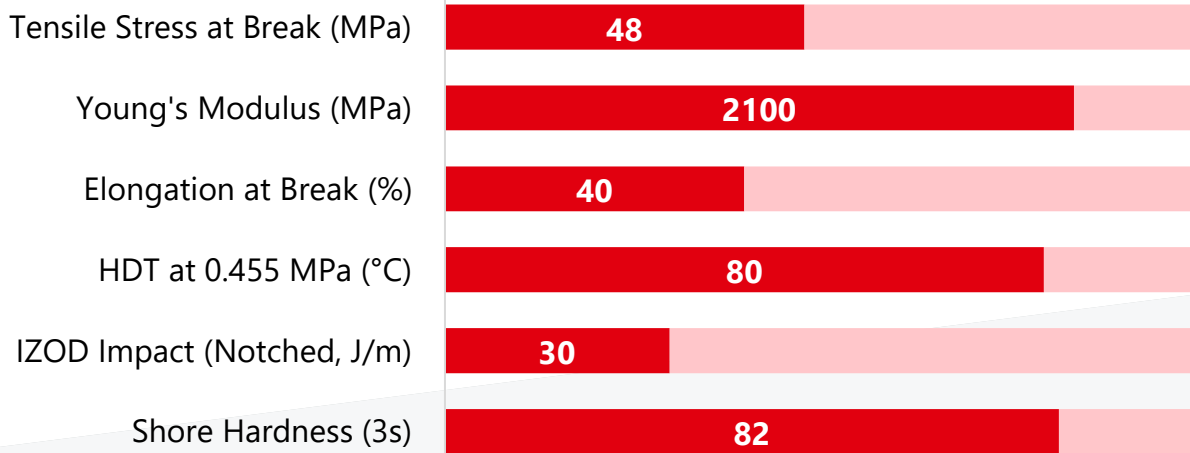
Industry



Automotive



Consumer Goods



*\*Values shown are linked to LOCTITE IND6845 BK as reference.*





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## PROPERTIES

Mechanical Properties	Measure	Method	Green	Post Processed
Young's Modulus	MPa	ASTM D638	1680 – 1830 <sup>[1]</sup>	1980 - 2200 <sup>[1]</sup>
Tensile Stress at Yield	MPa	ASTM D638	41 – 43 <sup>[1]</sup>	55 - 59 <sup>[1]</sup>
Elongation at Yield	%	ASTM D638	4.1 – 4.6 <sup>[1]</sup>	4.4 – 5.6 <sup>[1]</sup>
Tensile Stress at Break	MPa	ASTM D638	32 – 34 <sup>[1]</sup>	47 – 49 <sup>[1]</sup>
Elongation at Break	%	ASTM D638	56 – 64 <sup>[1]</sup>	35 – 45 <sup>[1]</sup>
Flexural Modulus	MPa	ASTM D790	-	1960 – 2300 <sup>[1]</sup>
Flexural Stress at Break	MPa	ASTM D790	-	80 – 95 <sup>[1]</sup>
Flexural Elongation at Break	%	ASTM D790	-	>5 <sup>[1]</sup>
IZOD Impact (Notched)	J/m	ASTM D256	-	28 – 35 <sup>[5]</sup>
Shore Hardness (3s)	D	ASTM D2240	-	81 – 83 <sup>[2]</sup>
<b>Other Properties</b>				
HDT at 0.455 MPa	°C	ASTM D648	-	80 – 85 <sup>[3,4]</sup>
HDT at 1.82 MPa	°C	ASTM D648	-	62 – 68 <sup>[3,4]</sup>
Water Absorption (24hr)	%	ASTM D570	-	2.1 – 2.5 <sup>[2]</sup>
Water Absorption (48hr)	%	ASTM D570	-	2.7 – 3.1 <sup>[2]</sup>
Water Absorption (72hr)	%	ASTM D570	-	3.3 – 3.7 <sup>[2]</sup>
Solid Density	g/cm <sup>3</sup>	ASTM D1475	-	1.16 - 1.20 <sup>[2]</sup>
Thermal Conductivity	W/(m·K)	ASTM D5930	-	0.20 – 0.21 <sup>[12]</sup>
Heat Capacity	J/(g·K)	ASTM D5930	-	1.2 – 1.3 <sup>[12]</sup>
Horizontal Burning Test	-	UL94	-	HB at 1.6 mm <sup>[13]</sup>

**Test parameters:**

"All specimen are printed unless otherwise noted. All specimen were conditioned in ambient lab conditions at 19-23°C / 40-60% RH for at least 24 hours." ASTM Methods: D638 Type IV, 5 mm/min, D790-B, 2 mm/min, D648, D256 Notched IZOD (Machine Notched), 6 mm x 12 mm, D570 0.125" x 2" Disc 24hr@ 25°C, D2240, Type "D" (0, 3 seconds), D7867, D1475  
\*The biological assessment has been performed based on the in vitro method according to ISO10993-23

**Internal Data Sources:**

[1] GEN730945 [2] FOR727326, [3] FOR716969, [4] FOR727226, [5] FOR729752, [12] FOR729029 [13] FOR728833





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## PROPERTIES

Liquid Properties	Measure	Method	Value
Viscosity at 25°C (77°F)	cP	ASTM D7867	719 - 769 [7,9]
Liquid Density	g/cm <sup>3</sup>	ASTM D1475	1.07 [8]
<b>Biocompatibility</b>			
Cytotoxicity		ISO10993-5	- Pending <sup>[13]</sup>

Electrical Properties	Measure	Method	Green	Post Processed
Volume Resistivity	Ω·cm	ASTM D257	-	5.1E+15 – 3.7E+15 <sup>[10]</sup>
Surface Resistivity	Ω	ASTM D257	-	9.9E+15 – 8.1E+15 <sup>[10]</sup>
Dielectric Strength	kV/mm	ASTM D149	-	14.4 – 13.8 <sup>[10]</sup>
AC Relative Permittivity (Dielectric Constant)				
at 50 Hz (XY)	none	ASTM D150	-	Pending <sup>[10]</sup>
at 1 kHz (XY)	none	ASTM D150	-	Pending <sup>[10]</sup>
at 1 MHz (XY)	none	ASTM D150	-	Pending <sup>[10]</sup>
AC Loss Characteristic (Dissipation Factor)				
at 50 Hz (XY)	none	ASTM D150	-	Pending <sup>[10]</sup>
at 1 kHz (XY)	none	ASTM D150	-	Pending <sup>[10]</sup>
at 1 MHz (XY)	none	ASTM D150	-	Pending <sup>[10]</sup>

\*All specimen are printed unless otherwise noted. All specimen were conditioned in ambient lab conditions at 19-23°C / 40-60% RH for at least 24 hours.\* ASTM Methods: D638 Type IV, 5 mm/min, D790-B, 2 mm/min, D648, D256 Notched IZOD (Machine Notched), 6 mm x 12 mm, D570 0.125" x 2" Disc 24hr@ 25°C, D2240, Type "D" (0, 3 seconds), D7867, D1475

Internal Data Sources:

[7] FOR724418, [8] FOR698029, [9] FOR723322, [10] FOR728734, [13] FOR740852





## WORKFLOW

Validated workflows need to be followed to achieve properties as provided in the TDS. Examples of validated workflow steps are listed below. Users should defer to the most current workflow information for best results which can be found at <https://www.loctiteam.com/printer-validation-settings>

## PRINTER SETTINGS

LOCTITE 3D IND6845 BK is formulated to print optimally on DLP and LCD printers. Read the safety data sheet carefully to get details about health and safety instructions. Recommended print parameters:

- Shake resin bottle well before usage
- Temperature: 20°C to 35°C
- Intensity: 1.5 mW/cm<sup>2</sup> to 5 mW/cm<sup>2</sup>

Printer Settings			385 nm and 5.0 mW/cm <sup>2</sup>	405 nm and 1.75 mW/cm <sup>2</sup>
Parameter	Measure	Method	Exposure time	Exposure time
Layer Thickness	µm	Internal	100	100
Burn-in Region	s	Internal	5	25
Transition Region	s	Internal	-	16
Model Region	s	Internal	5.5	8

Parameter	Measure	Method	Value	Value
E <sub>C</sub>	mJ/cm <sup>2</sup>	Internal	9.3 <sup>[11]</sup>	5.1 <sup>[12]</sup>
D <sub>p</sub>	mm	Internal	0.16 <sup>[11]</sup>	0.16 <sup>[12]</sup>

Settings	Measure	Method	Exposure time	Exposure time
D <sub>C</sub> = 50 µm	s	Internal	1.76 <sup>[11]</sup>	3.6 <sup>[12]</sup>
D <sub>C</sub> = 100 µm	s	Internal	2.80 <sup>[11]</sup>	5.3 <sup>[12]</sup>

**Test parameters:**

\*Exposure times are calculated without a safety factor

**Internal data source:**

[11] FOR723725, [12] FOR718034





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### CLEANING

LOCTITE 3D IND6845 BK requires post processing to achieve specified properties. Prior to post curing, support structures should be removed from the printed part, and the part should then be washed. Use compressed air to remove residual solvent from the surface of the material between intervals.

Post Process Step	Agent	Method	Duration	Intervals	Additional Info
Cleaning Step #1	Cleaner C	Ultrasonic	2 min	1 or 2	Dry after each interval
Cleaning Step #2	IPA	Ultrasonic	1 min	1	
Dry	n.a.	Compressed air	10 s to 60 s	1	Air pressure (50psi)
Wait before post curing	n.a.	Ambient condition	60 min	1	Room temperature

### POST CURING

LOCTITE 3D IND6845 BK requires a two-step post curing to achieve specified properties. In the first step it is recommended that either an LED or wide spectrum lamp be used to UV post cure parts. In the second step the UV post cured parts require an additional Heat post cure to achieve final properties.

#### STEP 1: UV post cure

UV Curing Unit	UV Source	Intensity	Cure time per side	Additional Settings (Shelf, Output Energy)
Loctite CL36	405nm LED	80 mW/cm <sup>2</sup> at 405 nm	30 min	100% top and side
Prusa CW1S	405nm LED	15 mW/cm <sup>2</sup> at 405 nm	30 min	100%





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## POST CURING

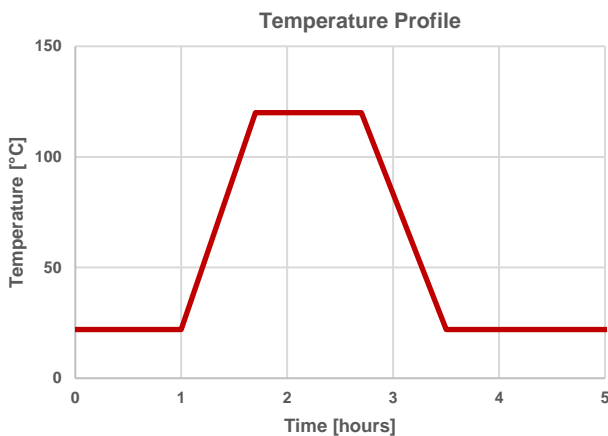
LOCTITE 3D IND6845 BK requires a two-step post curing to achieve specified properties.

### STEP 2: Heat post cure – Using a printer at 385 nm

After UV post curing, an additional Heat post cure at 120°C for 1 hours is required to reach final properties. Let parts rest one hour between UV post cure and Heat post cure.

To minimize risk of warpage place parts in the oven at standard lab conditions with  $T_{\text{start}} = 22^{\circ}\text{C}$  before ramping temperature with are rate of  $R_T \leq 5^{\circ}\text{C}/\text{min}$  to target value of  $T_{\text{cure}} = 120^{\circ}\text{C}$ .

After 1 hour at  $T_{\text{cure}} = 120^{\circ}\text{C}$  cool down parts slowly in the switched off oven to standard lab conditions with  $T_{\text{end}} = 22^{\circ}\text{C}$  . Do not remove the parts from the oven before they reached lab temperature to prevent thermal stress and warpage.





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## POST CURING

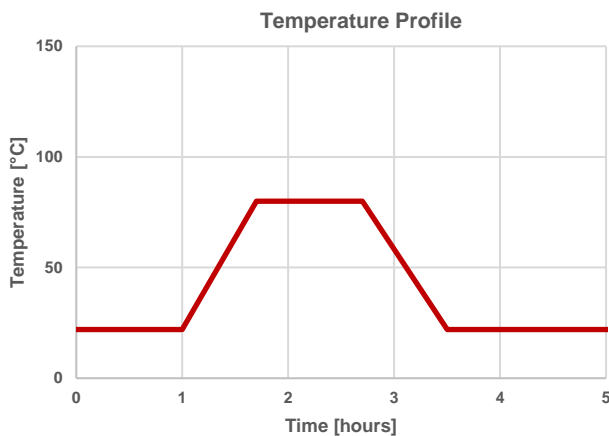
LOCTITE 3D IND6845 BK requires a two-step post curing to achieve specified properties.

### STEP 2: Heat post cure – Using a printer at 405 nm

After UV post curing, an additional Heat post cure at 80°C for 1 hours is required to reach final properties. Let parts rest one hour between UV post cure and Heat post cure.

To minimize risk of warpage place parts in the oven at standard lab conditions with  $T_{\text{start}} = 22^{\circ}\text{C}$  before ramping temperature with are rate of  $R_T \leq 5^{\circ}\text{C}/\text{min}$  to target value of  $T_{\text{cure}} = 80^{\circ}\text{C}$ .

After 1 hour at  $T_{\text{cure}} = 80^{\circ}\text{C}$  cool down parts slowly in the switched off oven to standard lab conditions with  $T_{\text{end}} = 22^{\circ}\text{C}$ . Do not remove the parts from the oven before they reached lab temperature to prevent thermal stress and warpage.





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## TIPS & TRICKS

This section is a collection of useful advices, guides, and recommendations designed to help users of **LOCTITE 3D IND6845 BK** deal with specific process tasks more efficiently.

### STORAGE

Store **LOCTITE 3D IND6845 BK** in the unopened container in a dry location. Optimal Storage: 20°C to 30°C. Storage below 20°C or above 30°C can adversely affect product properties. .

### RESIN USE

Use **LOCTITE 3D IND6845 BK** within two weeks after having opened the bottle to assure stable mechanical properties. Material removed from containers may be contaminated during use. For this reason, filter used resin with 190 µm mesh filter before placing back into proper storage container. Please use a separate container for used resin.

Reduce exposure to ambient light to achieve best resin performance.

### POST PROCESSING

Please start the post processing of **LOCTITE 3D IND6845 BK** within 24 hours after the print is finished. Gently remove green parts from the platform to achieve best part performance.



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## NOTE

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